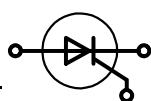
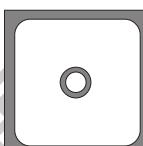


Type	Ag <sup>*</sup> Al <sup>*</sup>	V <sub>D<sub>RM</sub></sub> / V <sub>R<sub>RM</sub></sub>	V <sub>D<sub>SM</sub></sub> / V <sub>R<sub>SM</sub></sub> [V]	I <sub>T(AV)</sub> [A]	Chip Size [mm] x [mm]	Package Options
CWP 41-16 <input checked="" type="checkbox"/> <input checked="" type="checkbox"/>		1600	1700	72	10.00 10.0	  <p>sawn on foil <input checked="" type="checkbox"/>  unsawn wafer <input checked="" type="checkbox"/> *  in waffle pack <input checked="" type="checkbox"/></p>

\*Frontside options

\*Please contact  
IXYS chip sales

## Mechanical Parameters

Area active	0.50 cm <sup>2</sup>
Area total	1.00 cm <sup>2</sup>
Wafer size Ø	150 mm
Thickness	380 µm
Material	Si
Max. possible chips per wafer	141
Passivation front side	Glassivation
Metallization top side	solderable: Ti / Ni / Ag *
top side	bondable: 7 µm Al
Recom. wire bonds (Al)	Cathode    Gate
* = Stitchbonds      Number / Ø [µm]	12* / 500    1 / 500
Metallization backside	solderable (only): Ti / Ni / Ag *
Reject Ink Dot Size	Ø 0.4-1.0 mm
Recom. Storage Environment	
sawn on foil	in org. container, in dry nitrogen      < 6 month
unsawn wafer	in org. container, in dry nitrogen      < 2 year
in waffle pack	in org. container, in dry nitrogen      < 2 year
	T <sub>stg</sub> -40 ... 40 °C

\*Sinterable top/bottom side on request

## Features

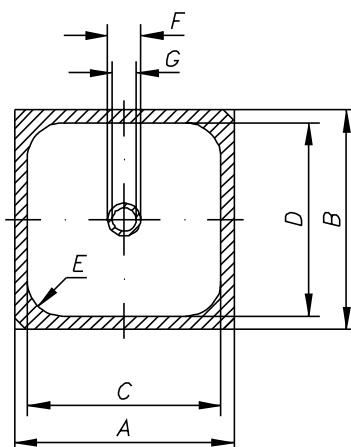
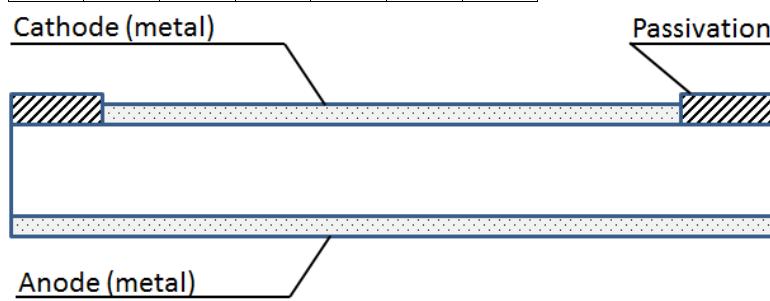
- planar design (non-mesa)
- ultra rugged for easy assembly (flat backside)
- excellent long term stability
- very low leakage current
- very low forward voltage drop

## Applications

- DC motor control
- AC power control
- Softstart AC motor controller
- Light, heat and temperature control
- Solid state relays
- Controlled rectifier circuits

## Dimensions

A [mm]	B [mm]	C [mm]	D [mm]	E [mm]	F [mm]	G [mm]
10.00	10.00	7.43	7.43	0.40	2.30	1.50



## Electrical parameters

Symbol	Conditions	Ratings		
		min.	typ.	max.
$I_R$ <sup>1)</sup>	$V_D = V_r = V_{rr}$ $T_{VJ} = 25^\circ C$ $T_{VI} = 150^\circ C$			0.05 mA 20 mA
$V_T$	$I_T = 200 A$ $T_{VJ} = 25^\circ C$ $T_{VI} = 150^\circ C$			1.53 V 1.60 V
$V_{TO}$ <sup>1)</sup>	For power-loss calculations only			0.92 V
$r_T$	$T_{VI} = 150^\circ C$			3.30 mΩ
$V_{GT}$	$V_D = 6 V$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$			1.5 V 1.6 V
$I_{GT}$	$V_D = 6 V$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$			95 mA 200 mA
$V_{GD}$	$T_{VJ} = 150^\circ C$ $V = \frac{2}{3} V_{DRM}$			0.2 V
$I_{GD}$				10 mA
$I_L$	$t_p = 10 \mu s$ $T_{VJ} = 25^\circ C$ $I_G = 0.45 A$ $di_G/dt = 0.45 A/\mu s$			450 mA
$I_H$	$R_{GK} = \infty$ $T_{VJ} = 25^\circ C$ $V_D = 6 V$			200 mA
$t_{gd}$	$V_D = \frac{1}{2} V_{DRM}$ $T_{VJ} = 25^\circ C$ $I_G = 0.5 A$ $di_G/dt = 0.5 A/\mu s$			2 μs
$t_q$	$V_R = 100 V$ $I_T = 120 A$ $-di/dt = 10 A/\mu s$ $t_p = 200 \mu s$ $dv/dt = 20 V/\mu s$ $V_D = \frac{2}{3} V_{DRM}$ $T_{VI} = 125^\circ C$			150 μs
$(di/dt)_a$	repetitive $I_T = 150 A$ non repetitive $I_T = 72 A$ $V = \frac{2}{3} V_{DRM}$ $T_{VJ} = 150^\circ C$ $di_G/dt = 0.45 A/\mu s$ $I_G = 0.45 A$ $t_p = 200 \mu s$ $f = 50 Hz$			150 A/μs 500 A/μs
$(dv/dt)_a$ <sup>1)</sup>	$T_{VJ} = 150^\circ C$ $V_{DR} = \frac{2}{3} V_{DRM}$ $R_{GK} = \infty$ method 1 (linear voltage rise)			1000 V/μs
$P_{GM}$	$T_{VJ} = 150^\circ C$ $t_p = 30 \mu s$ $t_p = 3E \mu s$			10 W 5 W 0.5 W
$P_{GAV}$				10 V
$V_{RGM}$				
$T_{VJ}$			-40	150 °C
$I_{T(AV)}$	$T_C = 100^\circ C$ 180° rect. $T_{VJ} = \quad^\circ C$ 180° sine			72 A 68 A
$I_{TSM}$ *	$T_{VJ} = 45^\circ C$ $t = 10 ms (50) Hz, sine$ $V_R = 0 V$ $t = 8.3 ms (60) Hz, sine$  $T_{VJ} = 150^\circ C$ $t = 10 ms (50) Hz, sine$ $V_R = 0 V$ $t = 8.3 ms (60) Hz, sine$			1150 A 1230 A  950 A 1000 A
$P_t$ *	$T_{VJ} = 45^\circ C$ $t = 10 ms (50) Hz, sine$ $V_R = 0 V$ $t = 8.3 ms (60) Hz, sine$  $T_{VJ} = 150^\circ C$ $t = 10 ms (50) Hz, sine$ $V_R = 0 V$ $t = 8.3 ms (60) Hz, sine$			6613 A s <sup>2</sup> 6279 A s <sup>2</sup>  4513 A s <sup>2</sup> 4150 A s <sup>2</sup>
$R_{thJC}$ *	DC current		0.5	K/W

\* Data according to assembled product MCC 44

Data according to IEC 60747

### Terms of Conditions and Usage

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Should you intend to use the product in aviation applications, in health or life endangering or life support applications, please notify. For any such applications we urgently recommend

- to perform joint risk and quality assessments;
- the conclusion of quality agreements;
- to establish joint measures to ensure application specific product capabilities and notify that IXYS may delivery dependent on the realization of any such measures.

